#### PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4973407

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
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Fu-Che Lee	05/03/2018

#### **RECEIVING PARTY DATA**

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City:	QUANZHOU CITY, FUJIAN PROVINCE
State/Country:	CHINA

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15952182

#### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	NAUP2868USA
NAME OF SUBMITTER:	SIBYL YU
SIGNATURE:	/SIBYL YU/
DATE SIGNED:	05/23/2018
	-

**Total Attachments: 4** 

PATENT 504926661 REEL: 045877 FRAME: 0441

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PATENT REEL: 045877 FRAME: 0442

## COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

#### Title of Invention:

#### SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME

As the below named inventor, I herel This declaration is directed to:	by decl	are that:			
☐ The attached application, or					
☑ United States application nu	mber	15/952,182	filed or	04/12/2018	, or
☐ PCT international application	n num	ber	filed	l on	
The above-identified application was	made	or authorized to	oe made by me.		
I believe that I am the original invente application.	or or ar	ı original joint inv	entor of a claimed	invention in the	
I hereby acknowledge that any willful under18 U.S.C. 1001 by fine or impri					
In consideration of the payment by	UNITI		ECTRONICS	having a postal a	iddress of
No.3, Li-Hsin Road 2, Science	-Base	d Industrial P	ark, Hsin-Chu	City 300, Taiw	an, R.O.C.
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good an	l of the	e sum of One Do able consideration	llar (\$ 1.00), the re 1.	eceipt of which is	hereby
In consideration of the payment by	Fujiaı Co., L		rated Circuit	having a postal a	ddress of
No.88, Lianhua Avenue, Integ Fujian Province 362200, P.R.C		Circuit Sciend	e Park, Jinjian	g City, Quanz	hou City,
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good an	l of the	e sum of One Do able consideration	llar (\$ 1.00), the re	eceipt of which is	hereby
I hereby sell, assign and transfer to A the entire right, title and interest in ar invention as above-identified applica invention by the above application or substitutes, or extensions thereof, an	nd to ar tion and any co	ny and all improved, in and to, all Le ontinuations, cont	ements which are etters Patent to be inuation-in-part, d	disclosed in the obtained for said ivisions, renewals	l S.
I hereby covenant that no assignmer entered into which would conflict with	nt, sale, n this a	agreement or erssignment;	ncumbrance has b	een or will be ma	de or
I further covenant that ASSIGNEE w and documents relating to said inven known and accessible to I and will te related thereto and will promptly exec	tion an stify as	d said Letters Pa to the same in a	itent and legal equ ny interference, lit	iivalents as may l igation proceedin	oe .

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NPO#NAU-P2868-USA:0 CUST#UMCF-2016-0062 F#NPO-P0002E-US1201 DSB0-106U036466

Docket No NAUP2868USA

representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof. IN WITNESS WHEREOF, I have hereunto set hand and seal this MAY () 3 2018 (Date of signing)

Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use this form for <u>each additional inventor</u>.

LEGAL NA	ME OF INVENTOR(ASSIGNOR)			
Inventor:	Wen-Fu Huang	Date:	MAY 0 3 2018	
Signature:	Wer Fullwarg			_

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NPO#NAU-P2868-USA:0 CUST#UMCF-2016-0062 F#NPO-P0002E-US1201 DSB0-106U036466

# COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

#### Title of Invention:

### SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME

As the below named inventor, I here This declaration is directed to:	by decl	are that:					
☐ The attached application, or							
☑ United States application nu	mber	15/952,182		filed on	04/12/2018	,	or
☐ PCT international application	n numi	ber		filed	on		
The above-identified application was	made	or authorized to	be made l	oy me.			
I believe that I am the original inventapplication.	or or an	n original joint in	ventor of a	claimed i	nvention in the	;	
I hereby acknowledge that any willfu under18 U.S.C. 1001 by fine or impri	l false s sonme	statement made nt of not more t	in this dec han five (5)	laration is years, or	punishable both.		
	UNITE CORF	ED MICROEL P.	ECTRON	IICS h	aving a postal	addre	ess of
No.3, Li-Hsin Road 2, Science	-Base	d Industrial I	Park, Hsi	n-Chu C	ity 300, Taiv	van,	R.O.C.
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good an	l of the	e sum of One Dable consideration	ollar (\$ 1.0 on.	0), the red	ceipt of which i	s here	eby
	Fujiar Co., L	n Jinhua Inte .td.	grated C	ircuit h	aving a postal	addre	ess of
No.88, Lianhua Avenue, Integ Fujian Province 362200, P.R.C	rated (	Circuit Scien	ce Park,	Jinjiang	City, Quan	zhou	City,
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good an	l of the	e sum of One D able consideration	ollar (\$ 1.0 on.	0), the red	ceipt of which i	s here	eby
I hereby sell, assign and transfer to A the entire right, title and interest in ar invention as above-identified applica- invention by the above application or substitutes, or extensions thereof, an	nd to an tion and any co	ny and all improd d, in and to, all l ontinuations, cor	vements wi _etters Pate ntinuation-i	hich are d ent to be d n-part, div	isclosed in the obtained for sa	id Ils.	E
I hereby covenant that no assignmer entered into which would conflict with	it, sale, ithis as	agreement or essignment;	encumbran	ce has be	en or will be m	ade o	or
I further covenant that ASSIGNEE wi and documents relating to said inven known and accessible to I and will te related thereto and will promptly exec	tion and stify as	d said Letters P to the same in	atent and I any interfer	egal equiv	valents as mav	be	5

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NPO#NAU-P2868-USA:0 CUST#UMCF-2016-0062

F#NPO-P0002E-US1201 DSB0-106U036466

Docket No NAUP2868USA

representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, I have hereunto set hand and seal this WAY 0.3.2018 (Date of signing)

Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use this form for <u>each additional inventor.</u>

LEGAL NAM	E OF INVENTOR(AS	SSIGNOR)					
Inventor:	Fu-Che Lee		Date:	MAY	03	2018	
Signature:	> Fu-Che	Leo					

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